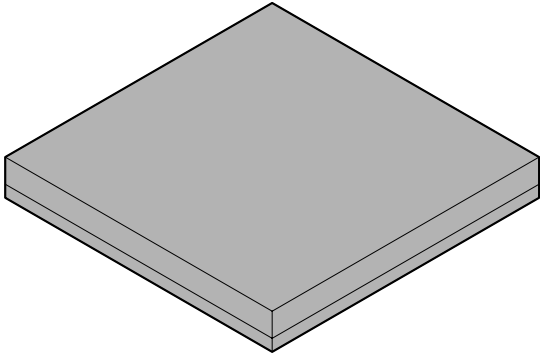
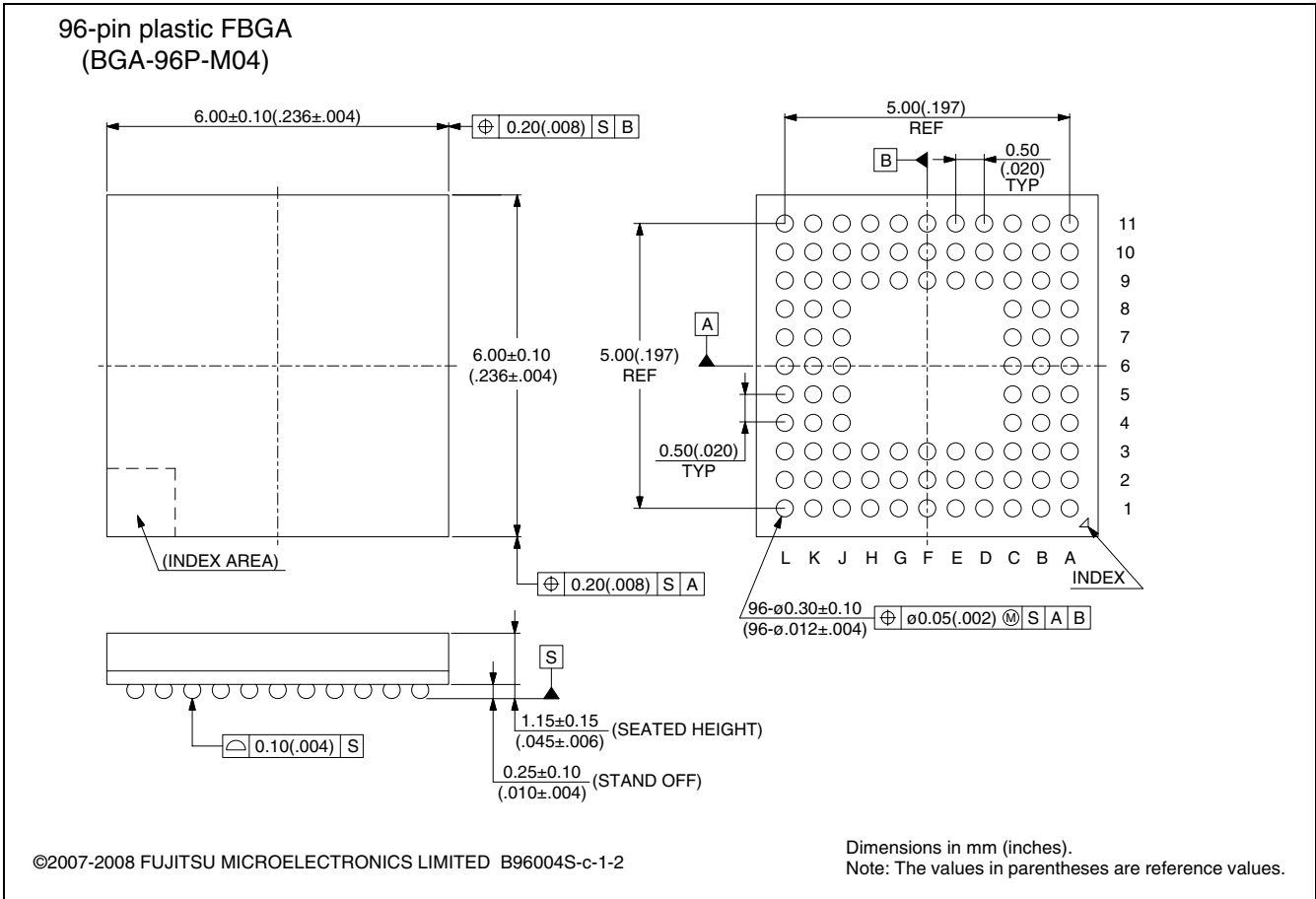


BGA-96P-M04

<p>96-pin plastic FBGA</p>  <p>(BGA-96P-M04)</p>	Lead pitch	0.50 mm
	Package width × package length	6.00 mm × 6.00 mm
	Lead shape	Ball
	Sealing method	Plastic mold
	Mounting height	1.30 mm MAX
	Weight	0.075 g



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